

# PTM-50X-B/BP

# Projection

# Blue and Blue Pump LED



### **Features**

- Blue and Blue Pump LED with 5.0 mm<sup>2</sup> emitting area designed for display
- Complement with PTM-50X Red Amber and Converted Green for best projection brightness and color gamut
- Dominant wavelength: Blue/Blue Pump 457/444 nm (Typ.)
- LED die precision mounted on low thermal resistance isolated MC-PCB package
- Thermistor pad allows option for precise thermal management
- Drive current up to 16 A
- Chipset array in series enabling lower drive current
- Windowless package allows for closer collection optics and brighter system solutions
- LED emitting area optimized for micro-display diagonal sizes ranging from 0.45" to 0.65"





## **Applications**

- Specifically engineered for Pico front projectors, head-up projection displays and hybrid projectors
- Suitable for DLP™, LCoS and HTPS /3LCD microdisplays

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# **Ordering Information**

### Ordering Part Numbers1

| Radiometric Flux |               | tric Flux <sup>2</sup> | Bin kit Ordering | Wayalangth Bin |                                   |
|------------------|---------------|------------------------|------------------|----------------|-----------------------------------|
| Color            | Min. Flux Bin | Min. Power             | Code             | Wavelength Bin | Ordering Part Number <sup>3</sup> |
| Blue             | 4F            | 19.6 W                 | EPF              | B6, B7         | PTM-50X-B-L34-EPF                 |
|                  | 4G            | 21.3 W                 | EPG              | B6, B7         | PTM-50X-B-L34-EPG                 |
| Blue Pump        | 4G            | 21.3 W                 | EPG              | B0, B1         | PTM-50X-BP-L34-EPG                |
|                  | 4H            | 23.3 W                 | EPH              | B0, B1         | PTM-50X-BP-L34-EPH                |

#### **Part Number Nomenclature**

PTM 50X ## L34 <Bin kit>

| Product Family                          | Chip Area                  | Color                    | Package Configuration   | Bin Kit <sup>4,5</sup>                                |
|---|----------------------------|--------------------------|---|---|
| PTM: Projection<br>Technology Multi-Die | 50: 5.0 mm²<br>X: Isolated | B: Blue<br>BP: Blue Pump | L34: No Connector,<br>Core board, Windowless<br>(See Mechanical<br>Drawing section) | Refer to ordering<br>part numbers in this<br>document |

- 1. Ordering part numbers represent bin kits (group of bins that are shippable for a given ordering part number)
- 2. Flux Bin listed is minimum bin shipped, higher bins may be included at Luminus' discretion.
- 3. Ordering Part number is default to L34 package configuration.
- 4. Individual flux bins are not orderable.
- 5. See Bin Kit and Flux / Power bin definitions on page 3.

# **Binning Structure**

#### Flux Bins<sup>1,2</sup>

| Color            | De l'acceptain Flore Din 2        | Binning @ 10 A, T <sub>j</sub> = 25°C <sup>4,5</sup> |                   |  |
|------------------|-----------------------------------|--|-------------------|--|
| COIOI            | Radiometric Flux Bin <sup>3</sup> | Minimum Power (W)                                    | Maximum Power (W) |  |
| Blue / Blue Pump | 4F                                | 19.6   | 21.3              |  |
|                  | 4G                                | 21.3   | 23.3              |  |
|                  | 4H                                | 23.3   | 25.3              |  |
|                  | 4J                                | 25.3   | 27.3              |  |

### Dominant Wavelength Bins<sup>1,2</sup>

| 0.1       | Wassalan ad Dis 2           | Binning @ 10 A, T <sub>j</sub> = 25°C <sup>4,5</sup> |                         |  |
|-----------|-----------------------------|--|-------------------------|--|
| Color     | Wavelength Bin <sup>3</sup> | Minimum Wavelength (nm)                              | Maximum Wavelength (nm) |  |
|           | В0                          | 441  | 447                     |  |
| Blue Pump | B1                          | 447  | 450                     |  |
| DI.       | B6                          | 453  | 460                     |  |
| Blue      | B7                          | 460  | 465                     |  |

- 1. Luminus maintains a +/- 6% tolerance on flux and power measurements, and a +/- 1nm tolerance on wavelength measurements.
- 2. Products are production tested then sorted and packed by bin.
- 3. Individual bins are not orderable. Please refer to the Product Ordering information page for a list of orderable bin kits.
- 4. Product test condition: 10 A, 20 ms single pulse, 25°C = heat sink temperature =  $T_{hs} = T_{j}$
- 5. T<sub>i</sub>= Junction temperature.
- 6. Wavelength bins are not orderable. Wavelength bins are displayed in product label.

# **Absolute Maximum Ratings**

|  | Symbol                | Values | Unit |
|--|-----------------------|--------|------|
| Absolute Maximum Reverse Drive Current (CW or Pulsed) <sup>1,2</sup>                           | l<br>r max            | 0      | mA   |
| Absolute Minimum Forward Current (CW or Pulsed) <sup>2</sup>                                   | I <sub>f min</sub>    | 0.2    |      |
| Absolute Maximum Forward Current (CW) <sup>3</sup>   | I <sub>f max CW</sub> | 13.0   | A    |
| Absolute Maximum Forward Current (Pulsed) <sup>3,4</sup> (Frequency > 240Hz, duty cycle < 70%) | <br>  f max Pulsed    | 16.0   | A    |
| Absolute Maximum Surge Current <sup>3,4</sup> (Frequency >240Hz, duty cycle = 10%, t=1ms)      | l<br>surge max        | 17.0   | А    |
| Absolute Minimum Storage Temperature   | T <sub>s min</sub>    | -40    | *0   |
| Absolute Maximum Storage Temperature   | T <sub>s max</sub>    | 100    | °C   |
| Absolute Maximum Junction Temperature  | T <sub>j max</sub>    | 150    | °C   |
| ESD sensitivity ANSI/ESDA/JEDEC JS-001 (HBM, Class 3A)   | V <sub>ESD</sub>      | 4000   | V    |

- 1. Reverse Current Operation is not allowed.
- 2. Product performance and lifetime data is specified at recommended forward drive currents. Sustained operation at or near absolute minimum currents may result in a reduction of device performance and device lifetime compared to recommended forward currents.
- 3. Sustained operation above maximum currents is not recommended and will result in a reduction of device lifetime compared to specified maximum forward drive currents. Device lifetimes will depend on junction temperature.
- 4. In pulsed operation, rise time from 10% to 90% of forward current should be larger than 0.5 microseconds.

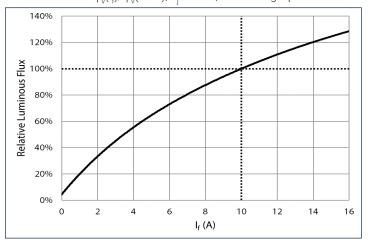
## **Device Characteristics**

| General Characteristics                                       | Symbol                       | Blue        | Blue Pump   | Unit    |  |
|---|------------------------------|-------------|-------------|---------|--|
| Emitting Area   | A <sub>E</sub>               | 4.93        | 4.93        | mm²     |  |
| Emitting Area Dimension                                       |                              | 3.30 x 1.54 | 3.30 x 1.54 | mm x mm |  |
| Optical and Electrical Characteristics <sup>1</sup>           |                              |             |             |         |  |
| Test Pulse Duration   |                              | 20          | 20          | ms      |  |
| Test Peak Drive Current <sup>2</sup>                          | l <sub>f</sub>               | 10          | 10          | А       |  |
| Peak Luminous Flux <sup>2</sup>                               | $\phi_{v}$                   | 920         | 500         | lm      |  |
| Peak Radiometric Flux <sup>2</sup>                            | $\Phi_{\rm r}$               | 22.7        | 25.7        | W       |  |
|   | $V_{fmin}$                   | 6.8         | 6.8         |         |  |
| Forward Voltage   | $V_{f}$                      | 7.4         | 7.4         | V       |  |
|   | $V_{f max}$                  | 8.0         | 8.0         |         |  |
|   | $\lambda_{	ext{d milin}}$    | 453         | 440         | nm      |  |
| Dominant Wavelength   | $\lambda_{d}$                | 457         | 444         |         |  |
|   | $\lambda_{	ext{d max}}$      | 465         | 450         |         |  |
| Peak Wavelength   | $\lambda_{p}$                | 453         | 436         | nm      |  |
| FWHM- Spectral bandwidth at 50% of $\Phi_{\rm r}$             | $\Delta\lambda_{_{1/2}}$     | 20          | 20          | nm      |  |
|   | CIE x                        | 0.15        | 0.16        |         |  |
| Chromaticity Coordinates <sup>3</sup>                         | CIE y                        | 0.03        | 0.01        |         |  |
| Thermal Characteristics                                       |                              |             |             |         |  |
| Thermal Resistance (junction to case) real <sup>4</sup>       | R <sub>øj-c real</sub>       | 0.68        | 0.68        | °C/W    |  |
| Thermal Resistance (junction to case) electrical <sup>4</sup> | R <sub>0j-c electrical</sub> | 0.46        | 0.44        | °C/W    |  |

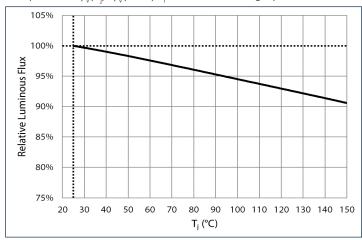
- 1. Characteristics at 10 A, 20 ms single pulse, 25°C
- 2. Unless otherwise noted, values listed are typical. All ratings are based on operation with a constant temperature =  $25^{\circ}$ C =  $T_{hs}$  =  $T_{j}$
- 3. In CIE 1931 chromaticity diagram coordinates, normalized to X+Y+Z=1.
- 4. Measurements are in accordance with JEDEC 51-14.

### Relative Luminous Flux - Blue

Forward current:  $\phi_v(I_f)/\phi_v(10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

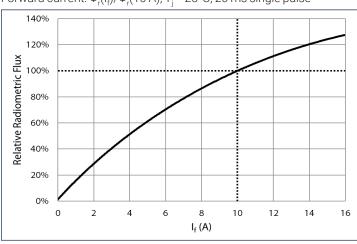


Temperature:  $\varphi_v(T_i)/\varphi_v(25^{\circ}C)$ , I<sub>f</sub> = 10 A, 20 ms single pulse

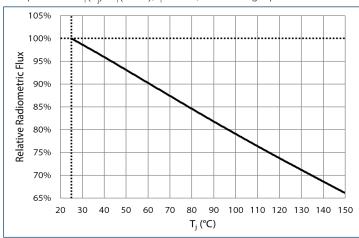


#### Relative Radiometric Flux - Blue

Forward current:  $\Phi_r(I_f)/\Phi_r(10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

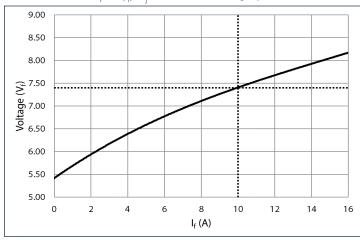


Temperature:  $\Phi_r(T_i)/\Phi_r(25^{\circ}C)$ ,  $I_f = 10$  A, 20 ms single pulse

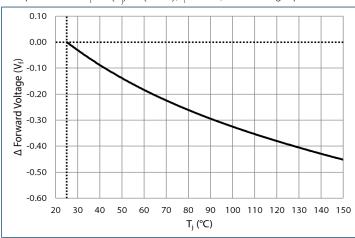


#### Forward Voltage - Blue

Forward current:  $V_f = V(I_f)$ ,  $T_i = 25$ °C, 20 ms single pulse

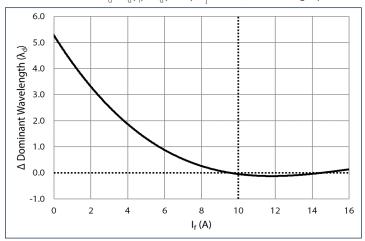


Temperature:  $\Delta V_f = V(T_i) - V(25^{\circ}C)$ ,  $I_f = 10$  A, 20 ms single pulse

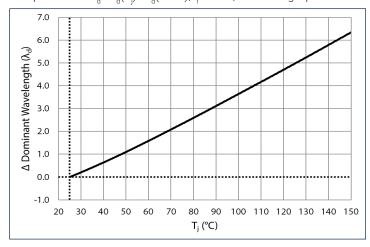


## Dominant Wavelength Shift - Blue

Forward current:  $\Delta \lambda_d = \lambda_d (I_f) - \lambda_d (10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

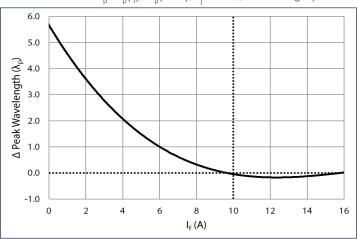


Temperature:  $\Delta \lambda_d = \lambda_d(T_i) - \lambda_d(25^{\circ}\text{C})$ , I<sub>f</sub> = 10 A, 20 ms single pulse

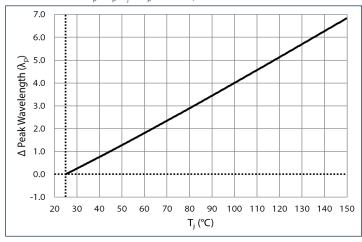


### Peak Wavelength Shift - Blue

Forward current:  $\Delta \lambda_n = \lambda_n (I_f) - \lambda_n (10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

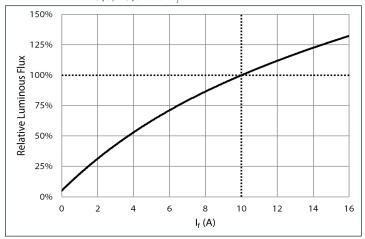


Temperature:  $\Delta \lambda_p = \lambda_p(T_i) - \lambda_p(25^{\circ}\text{C})$ , I<sub>f</sub> = 10 A, 20 ms single pulse

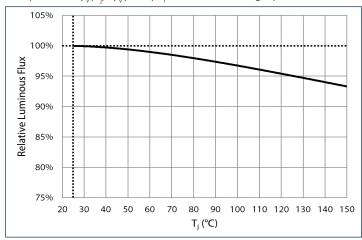


## Relative Luminous Flux - Blue Pump

Forward current:  $\phi_v(I_f)/\phi_v(10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

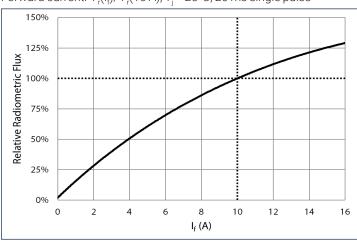


Temperature:  $\varphi_v(T_i)/\varphi_v(25^{\circ}C)$ , I<sub>f</sub> = 10 A, 20 ms single pulse

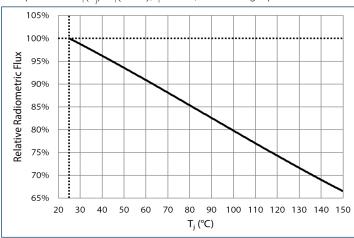


### Relative Radiometric Flux - Blue Pump

Forward current:  $\Phi_r(I_f)/\Phi_r(10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

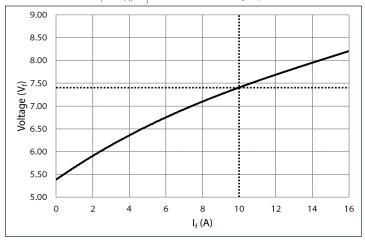


Temperature:  $\Phi_r(T_i)/\Phi_r(25^{\circ}C)$ ,  $I_f = 10$  A, 20 ms single pulse

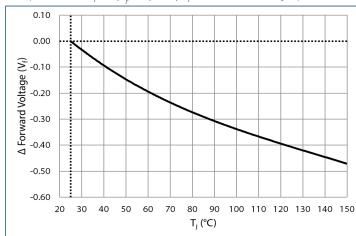


### Forward Voltage - Blue Pump

Forward current:  $V_f = V(I_f)$ ,  $T_i = 25$ °C, 20 ms single pulse

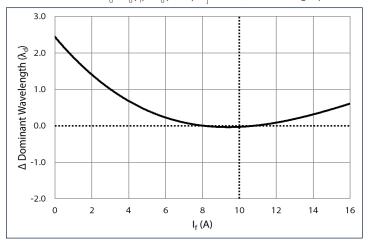


Temperature:  $\Delta V_f = V(T_f) - V(25^{\circ}C)$ ,  $I_f = 10$  A, 20 ms single pulse

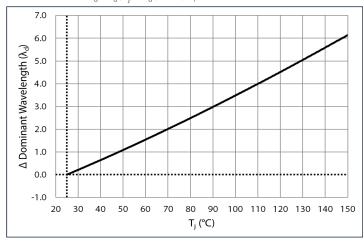


## **Dominant Wavelength Shift - Blue Pump**

Forward current:  $\Delta \lambda_d = \lambda_d (I_f) - \lambda_d (10 \text{ A})$ ,  $T_i = 25^{\circ}\text{C}$ , 20 ms single pulse

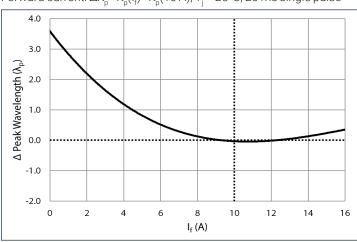


Temperature:  $\Delta \lambda_d = \lambda_d(T_i) - \lambda_d(25^{\circ}C)$ ,  $I_f = 10$  A, 20 ms single pulse

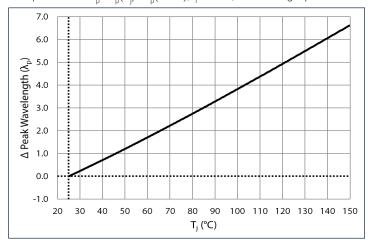


### Peak Wavelength Shift - Blue Pump

Forward current:  $\Delta \lambda_{D} = \lambda_{D}(I_{f}) - \lambda_{D}(10 \text{ A})$ ,  $T_{i} = 25^{\circ}\text{C}$ , 20 ms single pulse



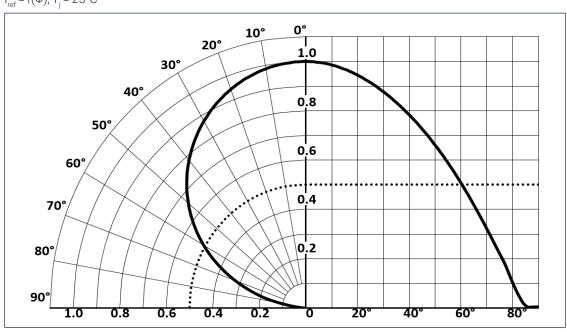
Temperature:  $\Delta \lambda_n = \lambda_n (T_i) - \lambda_n (25^{\circ}\text{C})$ ,  $I_f = 10 \text{ A}$ , 20 ms single pulse



# **Angular Distribution and Typical Spectrum**

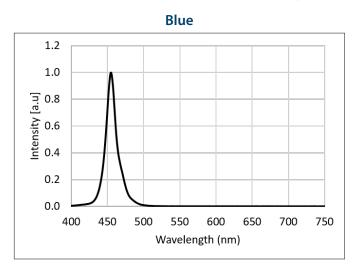
## Angular Intensity Distribution<sup>1</sup>

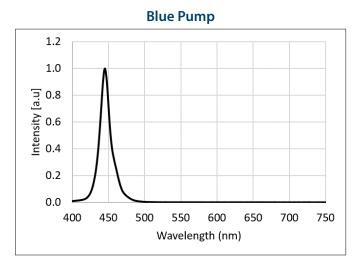
 $I_{ref} = f(\Phi); T_i = 25^{\circ}C$ 



## Typical Spectrum<sup>2</sup>

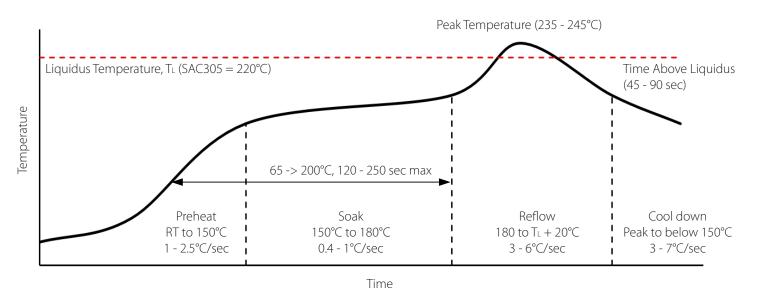
$$\Phi_{ref} = f(\lambda); I_f = 10 \text{ A}; T_j = 25^{\circ}\text{C}$$





- 1. For any specific device, slight variations may be expected.
- $2. \ Typical\ spectrum\ at\ recommended\ peak\ drive\ current.\ Please\ contact\ Luminus\ to\ obtain\ data\ in\ Excel\ format.$

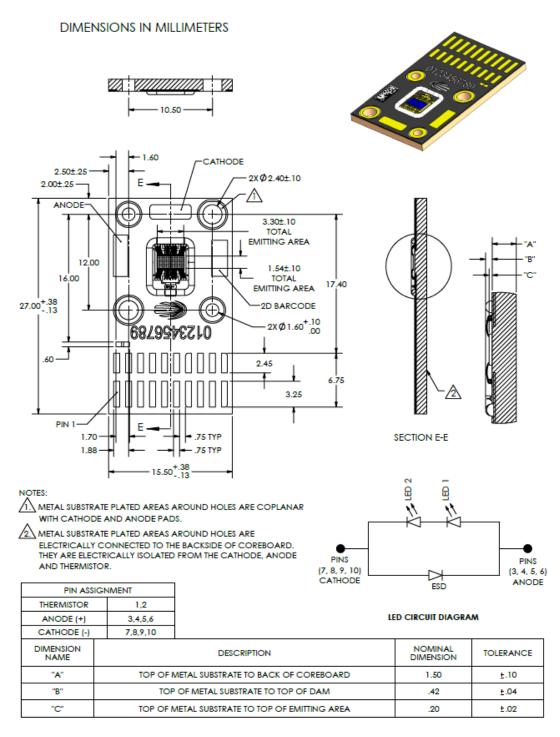
## **Soldering Profile**



| SMT Rework Guideline | Manual Hotplate Reflow | Hot Air Gun Reflow |
|----------------------|------------------------|--------------------|
| Heating Time         | < 60 sec               |                    |
| Hotplate Temperature | < 245°C                | < 150°C            |

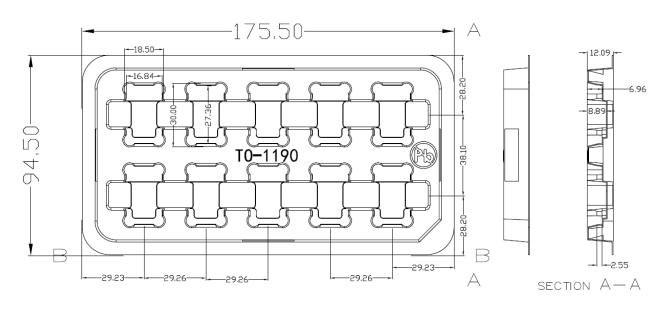
- 1. Product complies to Moisture Sensitivity Level 1 (MSL 1).
- 2. The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
- 3. During the pick and place process, ensure the pick-up tool does not touch any die components.
- 4. Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
- 5. Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB
- $6. \ Luminus\ recommends\ to\ use\ the\ solder\ paste\ data\ sheet\ information\ as\ a\ starting\ point\ in\ time\ temperature\ process\ development.$
- 7. These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application. For more information, please refer to:
  - $\underline{https://luminus devices.zendesk.com/hc/en-us/articles/360060306692-How-do-l-Reflow-Solder-Luminus-SMD-Components-to-learned and the substitution of the substituti$
- 8. For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.

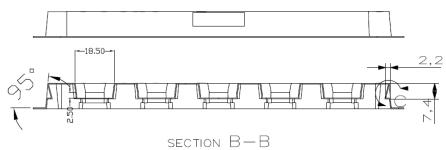
## **Mechanical Dimensions**

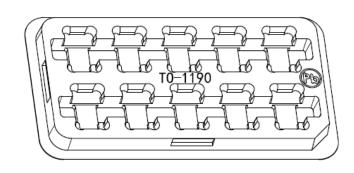


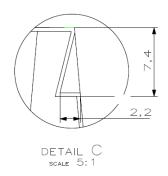
- 1. Die Tilt: 1° Maximum, Die Rotation: ±1°.
- 2. Contact within silicone dam area is prohibited.
- 3. Recommended connector: Manufacturer: Tarng-Yu; Part# TU1502WGR-10S-GO-M8-NL-A.
- $4. \ Recommended female connector: Manufacturer: Tarng-Yu; Part \#TU1502HNO-10; contact terminal part \#TU1502TGO-GO.$
- 5. LED coreboard backside is electrically isolated.
- 6. LED emitter and wirebond not covered, contact within the silicone dam area is prohibited.

# **Shipping Tray Outline**



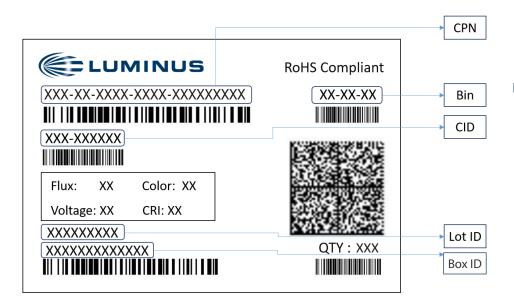






- 1. Each tray contains 10 units.
- 2. All dimensions are in millimeter ± 0.25 mm.
- 3. For detailed drawing of shipping tray, please refer to document TO-1190, available upon request.

# **Shipping Label**



#### **Label Fields:**

- CPN: Luminus ordering part number
- CID: Customer's part number
- QTY: Quantity of devices in pack
- Flux: Bin as defined on page 3
- Voltage: NA
- Color: Bin as defined on page 3
- CRI: NA

#### **Packing Configuration:**

- Stack of 5 trays with 10 devices per tray
- Partial pack or tray may be shipped
- Each pack is enclosed in anti-static bag
- Shipping label is placed on top of each pack

## **Notes**

### **Static Electricity**

This product is sensitive to static electricity, and care should be taken when handling them. Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or anti-electrostatic gloves when handling the LEDs. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken to isolate LED processing equipment from potential sources of voltage surges.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

#### **Eye Safety**

According to the test specification risk group IEC 62471: 2006-Non-GLS under 10 A, this product complies to Risk group 3 (RG3) High risk.

Do not stare at operating lamp, eye injury may result.

For more information, please refer to: <a href="https://luminusdevices.zendesk.com/hc/en-us/articles/10532958752397">https://luminusdevices.zendesk.com/hc/en-us/articles/10532958752397</a>

# **Revision History**

| Rev | Date       | Description of Change |
|-----|------------|-----------------------|
| 01  | 06/27/2024 | Initial release       |